#### Robo Pardaz.com طیالی، حالقاله و عیشالی، ویایه

CUSTOMER				
MODEL	CFAH1602A-AGB-JP			
APPROVAL	BY:	DATA:		

SALES BY	APPROVED BY	CHECKED BY	PREPARED BY

# **Crystalfontz America, Inc.**

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# **1.Module Classification Information**

1	Brand: CRYSTALFONTZ AMERICA, INCORPORATED								
2	Display Type: <b>H→Character Type</b> , G→Graphic Type								
3	Display's logical dimensions: 16 columns by 02 lines								
4	Model serials no.								
(5)	Backlight Type:	N→Without backlight Y→LED, Yellow Green							
		B→EL, Blue green	A→LED, Amber						
		D→EL, Green	R→LED, Red						
		W→EL, White	O→LED, Orange						
		F→CCFL, White	G→LED, Green						
6	LCD Mode:	B→TN Positive, Gray	M→STN Negative, Blue						
		N→TN Negative,	F→FSTN Positive						
		G→STN Positive, Gray	T→FSTN Negative						
		Y→STN Positive, Yellow Green							
7	LCD Polarizer Type,	A→Reflective, N.T, 6:00	H→Transflective, W.T,6:00						
	Temperature range,	D→Reflective, N.T, 12:00	K→Transflective, W.T,12:00						
	Viewing direction:	G→Reflective, W. T, 6:00	C→Transmissive, N.T,6:00						
		J→Reflective, W. T, 12:00	F→Transmissive, N.T,12:00						
		B→Transflective, N.T,6:00	I→Transmissive, W. T, 6:00						
		E→Transflective, N.T.12:00	L→Transmissive, W.T,12:00						
8	Special Code:	JP→English and Japanese standar	d font						

### 2.Precautions in use of LCD Modules

- (1)Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- (3)Don't disassemble the LCM.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist LCM.
- (6)Soldering: only to the I/O terminals.
- (7)Storage: please storage in anti-static electricity container and clean environment.

### **3.General Specification**

Item	Dimension	Unit
Number of Characters	16 characters x 2 Lines	_
Module dimension	84.0 x 44.0 x 13.5(MAX)	mm
View area	66.0 x 17.0	mm
Active area	56.20 x 11.5	mm
Dot size	0.55 x 0.65	mm
Dot pitch	0.60 x 0.70	mm
Character size	2.95 x 5.55	mm
Character pitch	3.55 x 5.95	mm
LCD type	STN, Positive, Transflective, Gray	
Duty	1/16	
View direction	6 o'clock	
Backlight Type	LED Amber	

# **4.Absolute Maximum Ratings**

Item	Symbol	Min	Тур	Max	Unit	
Operating Temperature	$T_{\mathrm{OP}}$	0	_	+50	$^{\circ}\!\mathbb{C}$	
Storage Temperature	$T_{ST}$	-10	_	+60	$^{\circ}\!\mathbb{C}$	
Input Voltage	V <sub>I</sub>	$V_{SS}$	_	$V_{\mathrm{DD}}$	V	
Supply Voltage For Logic	$V_{ m DD} ext{-}V_{ m SS}$	-0.3	_	7	V	
Supply Voltage For LCD	$V_{ m DD} ext{-}V_0$	-0.3	_	13	V	

# **5.Electrical Characteristics**

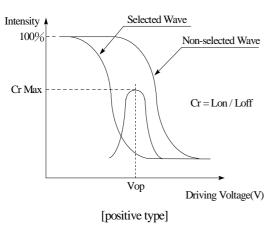
Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage For Logic	$V_{DD}$ - $V_{SS}$	_	4.5	_	5.5	V
		Ta=0°C	_		4.2	V
Supply Voltage For LCD	$V_{DD}$ - $V_0$	Ta=25°℃	_	3.8	_	V
		Ta=50°C	3.6	_	_	V
Input High Volt.	$V_{\mathrm{IH}}$	_	2.2		$V_{DD}$	V
Input Low Volt.	$V_{IL}$	_	_	_	0.6	V
Output High Volt.	$V_{OH}$	_	2.4	_	_	V
Output Low Volt.	$V_{\mathrm{OL}}$	_			0.4	V
Supply Current	$I_{\mathrm{DD}}$	V <sub>DD</sub> =5V	_	1.2	_	mA

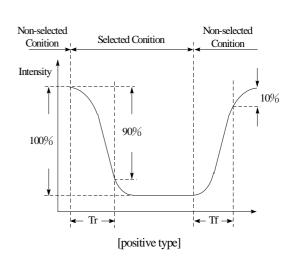
# **6.Optical Characteristics**

Item	Symbol	Condition	Min	Тур	Max	Unit
View Angle	(V) θ	CR≧2	10	_	105	deg
view rinigio	(H) φ	CR≧2	-30	_	30	deg
Contrast Ratio	CR	_	_	3	_	_
Response Time	T rise	_	_	150	200	ms
response Time	T fall	_	_	150	200	ms

#### **Definition of Operation Voltage (Vop)**

#### **Definition of Response Time (Tr, Tf)**

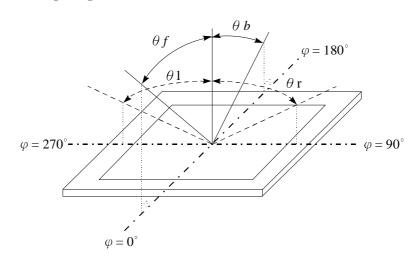




#### **Conditions:**

Operating Voltage : Vop Viewing Angle( $\theta$ ,  $\varphi$ ) :  $0^{\circ}$ ,  $0^{\circ}$  Frame Frequency : 64 HZ Driving Waveform : 1/N duty, 1/a bias

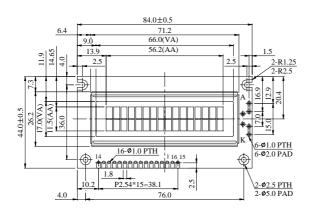
#### Definition of viewing angle( $CR \ge 2$ )



# 7.Interface Pin Function

Pin No.	Symbol	Level	Description
1	$V_{SS}$	0V	Ground
2	$V_{\mathrm{DD}}$	5.0V	Supply Voltage for logic
3	VO	(Variable)	Operating voltage for LCD
4	RS	H/L	H: DATA, L: Instruction code
5	R/W	H/L	H: Read(MPU→Module) L: Write(MPU→Module)
6	Е	H,H→L	Chip enable signal
7	DB0	H/L	Data bit 0
8	DB1	H/L	Data bit 1
9	DB2	H/L	Data bit 2
10	DB3	H/L	Data bit 3
11	DB4	H/L	Data bit 4
12	DB5	H/L	Data bit 5
13	DB6	H/L	Data bit 6
14	DB7	H/L	Data bit 7
15	A	_	LED +
16	K	_	LED-

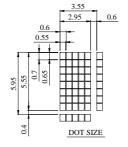
# 8.Contour Drawing & Block Diagram



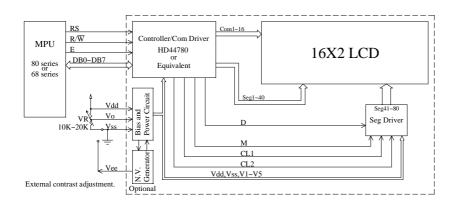


LED-H/L B/L							
	High	Low					
H1	13.5	12.1					
H2	8.9	7.5					

	PIN NO.	SYMBOL
	1	Vss
ı	2	Vdd
	3	Vo
i	4	RS
	5	R/W
	6	E
	7	DB0
	8	DB1
	9	DB2
	10	DB3
	11	DB4
	12	DB5
	13	DB6
	14	DB7
	15	A/Vee
	16	K



The non-specified tolerance of dimension is  $\pm 0.3$ mm.



LED B/L Drive Method

Drive from pin15, pin16

R R A B/L K LCM

(Will never get Vee output from pi

(will he ver get vee suspin from pr

Character located DDRAM address DDRAM address

1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
00	01	02	03	04	05	06	07	08	09	0A	0B	0C	0D	0E	0F
40	41	42	43	44	45	46	47	48	49	4 A	4R	4C	4D	4F	4F

### **9.Function Description**

The LCD display Module is built in a LSI controller, the controller has two 8-bit registers, an instruction register (IR) and a data register (DR).

The IR stores instruction codes, such as display clear and cursor shift, and address information for display data RAM (DDRAM) and character generator (CGRAM). The IR can only be written from the MPU. The DR temporarily stores data to be written or read from DDRAM or CGRAM. When address information is written into the IR, then data is stored into the DR from DDRAM or CGRAM. By the register selector (RS) signal, these two registers can be selected.

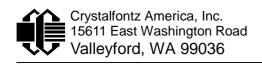
RS	R/W	Operation
0	0	IR write as an internal operation (display clear, etc.)
0	1	Read busy flag (DB7) and address counter (DB0 to DB7)
1	0	Write data to DDRAM or CGRAM (DR to DDRAM or CGRAM)
1	1	Read data from DDRAM or CGRAM (DDRAM or CGRAM to DR)

#### **Busy Flag (BF)**

When the busy flag is 1, the controller LSI is in the internal operation mode, and the next instruction will not be accepted. When RS=0 and R/W=1, the busy flag is output to DB7. The next instruction must be written after ensuring that the busy flag is 0.

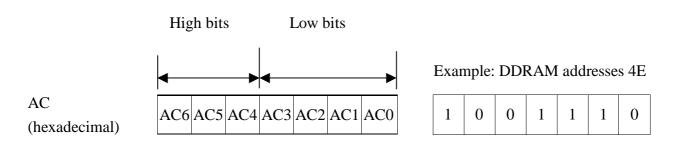
#### **Address Counter (AC)**

The address counter (AC) assigns addresses to both DDRAM and CGRAM

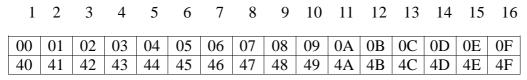


#### **Display Data RAM (DDRAM)**

This DDRAM is used to store the display data represented in 8-bit character codes. Its extended capacity is  $80 \times 8$  bits or 80 characters. Below figure is the relationships between DDRAM addresses and positions on the liquid crystal display.



Display position DDRAM address



2-Line by 16-Character Display

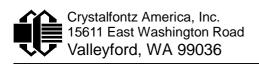
#### **Character Generator ROM (CGROM)**

The CGROM generate  $5 \times 8$  dot or  $5 \times 10$  dot character patterns from 8-bit character codes. See Table 2.

#### **Character Generator RAM (CGRAM)**

In CGRAM, the user can rewrite character by program. For  $5 \times 8$  dots, eight character patterns can be written, and for  $5 \times 10$  dots, four character patterns can be written.

Write into DDRAM the character code at the addresses shown as the left column of table 1. To show the character patterns stored in CGRAM.



# Relationship between CGRAM Addresses, Character Codes (DDRAM) and Character patterns

#### Table 1.

For 5 \* 8 dot character patterns

Character Codes (DDRAM data)	CGRAM Address	Character Patterns (CGRAM data)	
7 6 5 4 3 2 1 0	5 4 3 2 1 0	7 6 5 4 3 2 1 0	
High Low	High Low	High Low	
0 0 0 0 * 0 0 0	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	* * * * 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0	Character pattern(1)  Cursor pattern
0 0 0 0 * 0 0 1	$\begin{array}{cccccccccccccccccccccccccccccccccccc$	* * * * 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0	Character pattern(2)  Cursor pattern
	$\left  egin{array}{ccc} 0 & 0 & 0 \ 0 & 0 & 1 \end{array} \right $	* * *	
0 0 0 0 * 1 1 1	1 1 1 1 0 0 1 0 1 1 1 0 1 1 1	* * *	

For 5 \* 10 dot character patterns

5 <u>* 10 dot character patt</u>	erns															
Character Codes (DDRAM data)	C	G R A M	I A	d d	re s	s			act R A							
7 6 5 4 3 2 1 0		5 4	3	2	1	0	7	6	5	4	3	2	1	0		
High Low	I	ligh		Lo	w		I	H i g	h		L	o w	7			
			0	0	0	0	*	*	*	0	0	0	0	0	1	
			0	0	1	0	*	*	*		0	Ň	Ż	0		
			0	0 1	1	1	*	*	*		0	0	0			
0 0 0 0 * 0 0 0		0 0	0	1	0	1	*	*	*		0	0	0			
			0	1	1	0	*	*	*					0		Character
			0	1	1	1	*	*	*		0	0	0	0		pattern
			1	0	0	0	*	*	*		0	0	0	0		
			1	0	0	1	*	*	*		0	0	0	0	<u> </u>	<b>C</b>
			1	0	1	0	ጥ	<del>*</del>	ጥ	0	0	0	0	0	Į	Cursor pattern
								Į								
			1	1	1	1	*	*	*	*	*	*	*	*		

■ : " High "

# 10.Character Generator ROM Pattern

#### Table.2

Upper 4 bit																
4 bit Lower 4 bit	LLLL	LLLH	LLHL	LLHH	LHLL	LHLH	LHHL	СННН	HLLL	HLLH	HLHL	нгнн	HHLL	ннгн	нннг	нннн
LLLL	CG RAM (1)					<b></b> :		<b></b>					-===	···.	: <u>:</u> ::	<b> </b>  ::::
LLLH	(2)						-:::	-:::[			<b></b>			<u>-</u>	-===	
LLHL	(3)		::				<b></b> :	<b>!</b> -			:		<b>!</b>	.:-:		<b>!</b> !!!!
LLHH	(4)					=====	<b>:</b>	-:::-			!			====	===-	::-:=
LHLL	(5)							- <u> -</u>  -			٠.		i		<b></b>	====
LHLH	(6)			:			====	<b></b> .			::				=:::::	II
LHHL	(7)			====		II		<b>.</b>							<b> </b>	=====
LННН	(8)		:=	:-::			====	<b></b>			-:::				•	::::
HLLL	(1)		<b>:</b>	::		:-:	<b>!</b> :	:-::			.:i*	-=::		<b>!!</b>	E	
HLLH	(2)					-:-		:				•	!		!	
HLHL	(3)		:-[-:	==	!		:						•	<b></b>	i	
НЬНН	(4)			::			<b>!</b> -:	-			::=	-	=		:-:	
HHLL	(5)		:=		<u></u>							<b>∷.</b> .₌		<b>:</b>	• <b>:</b> [:-	
ННГН	(6)							-						=	====	:
нннг	(7)		::		<b>!</b> !	"	F							"-		
нннн	(8)						:::::	-=:			: :.:	٠!	:=	===	ı <u></u> ı	

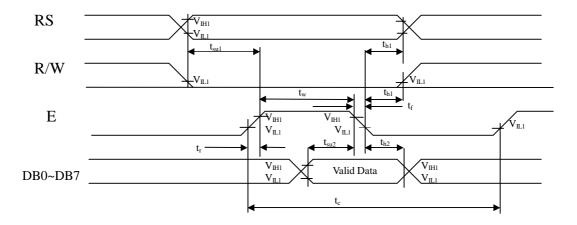
# 11.Instruction Table

Instruction				Ins	tructi	ion C	ode			Description	Execution time	
This i detion	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	_	(fosc=270Khz)
Clear Display	0	0	0	0	0	0	0	0	0	1	Write "00H" to DDRAM and set DDRAM address to "00H" from AC	1.53ms
Return Home	0	0	0	0	0	0	0	0	1	_	Set DDRAM address to "00H" from AC and return cursor to its original position if shifted. The contents of DDRAM are not changed.	1.53ms
Entry Mode Set	0	0	0	0	0	0	0	1	I/D	SH	Assign cursor moving direction and enable the shift of entire display.	39 μ s
Display ON/OFF Control	0	0	0	0	0	0	1	D	С	В	Set display (D), cursor (C), and blinking of cursor (B) on/off control bit.	39 μ s
Cursor or Display Shift	0	0	0	0	0	1	S/C	R/L	_	_	Set cursor moving and display shift control bit, and the direction, without changing of DDRAM data.	39 μ s
Function Set	0	0	0	0	1	DL	N	F	ı	_	Set interface data length (DL:8-bit/4-bit), numbers of display line (N:2-line/1-line)and, display font type (F:5×11 dots/5 × 8 dots)	39 μ s
Set CGRAM Address	0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0	Set CGRAM address in address counter.	39 μ s
Set DDRAM Address	0	0	1	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Set DDRAM address in address counter.	39 μ s
Read Busy Flag and Address	0	1	BF	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Whether during internal operation or not can be known by reading BF. The contents of address counter can also be read.	0 μ s
Write Data to RAM	1	0	D7	D6	D5	D4	D3	D2	D1	D0	Write data into internal RAM (DDRAM/CGRAM).	43 μ s
Read Data from RAM	1	1	D7	D6	D5	D4	D3	D2	D1	D0	Read data from internal RAM (DDRAM/CGRAM).	43 μ s

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# **12.Timing Characteristics**

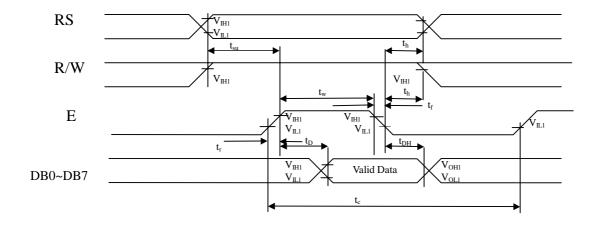
#### **12.1 Write Operation**



$$(V_{DD}=4.5V\sim5.5V, Ta=-30\sim+85^{\circ}C)$$

Mode	Characteristic	Symbol	Min.	Тур.	Max.	Unit
	E cycle Time	tc	500	_	_	
	E Rise/Fall Time	$t_R$ , $t_F$	_	_	20	
	E Pulse Width (High,	tw	230	_		
Write Mode	Low)					<b>m</b> .c
write wiode	R/W and RS Setup Time	tsu1	40	_	_	ns
	R/W and RS Hold Time	t <sub>H1</sub>	10	_	_	
	<b>Data Setup Time</b>	tsu2	80			
	Data Hold Time	$t_{\rm H2}$	10	_	_	

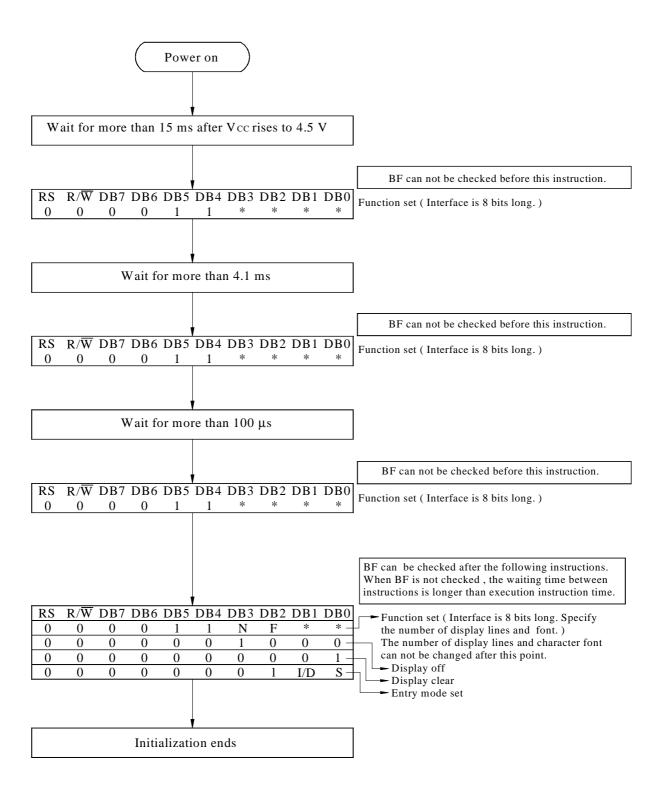
#### 12.2 Read Operation



$$(V_{DD}=4.5V\sim5.5V, Ta=-30\sim+85^{\circ}C)$$

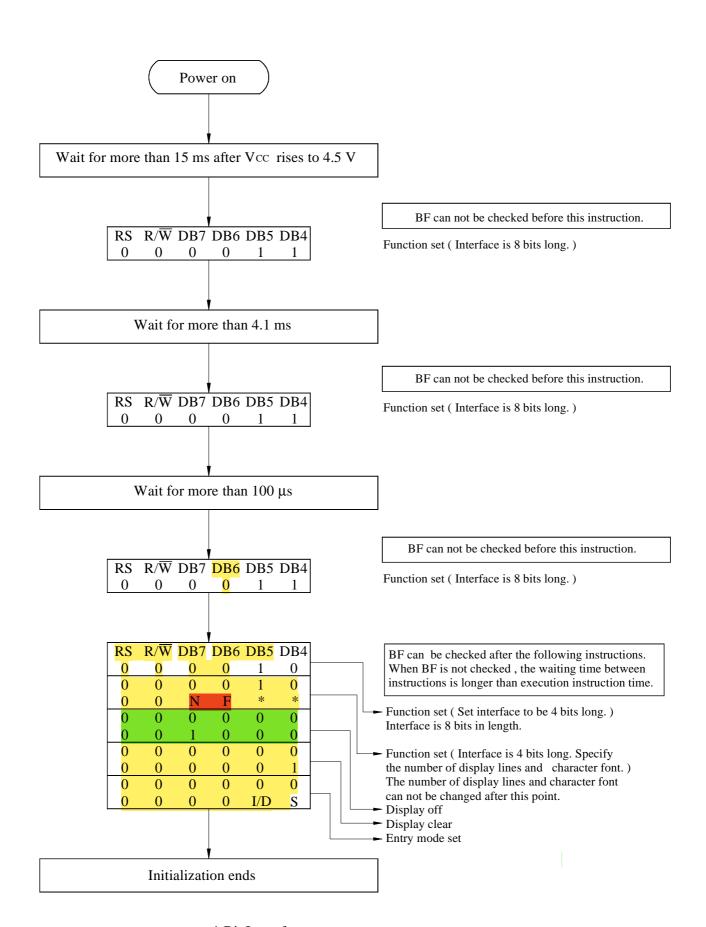
Mode	Characteristic	Symbol	Min.	Тур.	Max.	Unit
	E cycle Time	tc	500	_	_	
	E Rise/Fall Time	$t_R, t_F$	_	_	20	
	E Pulse Width (High,	tw	230	_	_	
Read Mode	Low)					ma
Read Mode	R/W and RS Setup Time	tsu	40	_	_	ns
	R/W and RS Hold Time	t <sub>H</sub>	10	_	_	
	<b>Data Output Delay Time</b>	$t_{\mathrm{D}}$	_	_	120	
	Data Hold Time	$t_{\mathrm{DH}}$	5	_	_	

# 13.Initializing of LCM



Fax:

8-Bit Ineterface



4-Bit Ineterface

# **14.Quality Assurance**

#### **Screen Cosmetic Criteria**

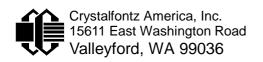
Item	Defect	Judgment Criterion	Partition
1	Spots	A)Clear  A)Clear  A)Clear  Acceptable Qty in active area $0.1 < d \le 0.1$ Disregard $0.1 < d \le 0.2$ $0.3 < d = 0$ Note: Including pin holes and defective dots which must be within one pixel size.  B)Unclear  Size: d mm  Acceptable Qty in active area $0.2 < d \le 0.2$ Disregard $0.2 < d \le 0.2$ $0.2 < d \le 0.3$ $0.3 < d \ge $	Minor
2	Bubbles in Polarize		Minor
3	Scratch	In accordance with spots cosmetic criteria. When the light reflects on the panel surface, the scratches are not to be remarkable.	Minor
4	Allowable Density	Above defects should be separated more than 30mm each other.	Minor
5	Coloration	Not to be noticeable coloration in the viewing area of the LCD panels.  Back-light type should be judged with back-light on state only.	Minor

# 15.Reliability

#### **Content of Reliability Test**

	Environmental T	<b>'est</b>	
Test Item	Content of Test	Test Condition	Applicable Standard
High Temperature storage	Endurance test applying the high storage temperature for a long time.	60°C 200hrs	
Low Temperature storage	Endurance test applying the high storage temperature for a long time.	-10°C 200hrs	
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	50°C 200hrs	
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	0°C 200hrs	
High Temperature/ Humidity Storage	Endurance test applying the high temperature and high humidity storage for a long time.	60°C ,90%RH 96hrs	
High Temperature/ Humidity Operation	Endurance test applying the electric stress (Voltage & Current) and temperature / humidity stress to the element for a long time.	50°C ,90% RH 96hrs	
Temperature Cycle	Endurance test applying the low and high temperature cycle.  -10°C 25°C 60°C  30min 5min 30min 1 cycle	-10°C/60°C 10 cycles	
	Mechanical Tes	t	
Vibration test	Endurance test applying the vibration during transportation and using.	10~22Hz→1.5mmp-p 22~500Hz→1.5G Total 0.5hrs	
Shock test	Constructional and mechanical endurance test applying the shock during transportation.	50G Half sign wave 11 msedc 3 times of each direction	
Atmospheric pressure test	Endurance test applying the atmospheric pressure during transportation by air.	115mbar 40hrs	
	Others		
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=800V,RS=1.5kΩ CS=100pF 1 time	

<sup>\*\*\*</sup>Supply voltage for logic system=5V. Supply voltage for LCD system =Operating voltage at  $25^{\circ}$ C



# **16.Backlight Information**

### **Specification**

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	TEST CONDITION
Supply Current	ILED		130	260	mA	V=4.2V
Supply Voltage	V	_	4.2	4.6	V	_
Reverse Voltage	VR	_	_	8	V	_
Luminous Intensity	IV	10	_	_	CD/M <sup>2</sup>	ILED=130mA
Wave Length	λρ		610	_	nm	ILED=130mA
Life Time	_	_	100000	_	Hr.	V≤4.6V
Color	Amber					1



مرمع دیکاشیت و اطلاعات روزائیگ